

**IN THE DRAWINGS:**

The attached sheets of drawings includes changes to Fig. 5 and Fig. 7. These sheets, which include Figs. 1-11B, replace the original sheets including Figs. 1-11B. In Fig. 5, reference numeral reference numeral "152" has been changed to "176," reference number "176" has been changed to "152," and reference numeral "200" has been changed to "213." In Fig. 7, reference numeral "48" has been changed to "748," and reference numeral "717" has been changed to "747." Also in Fig. 5, the position of reference numeral "756" has been moved, and reference numerals "750," "761," and "762: have been added.

**Attachment: Replacement Sheet  
Annotated Sheet Showing Changes**

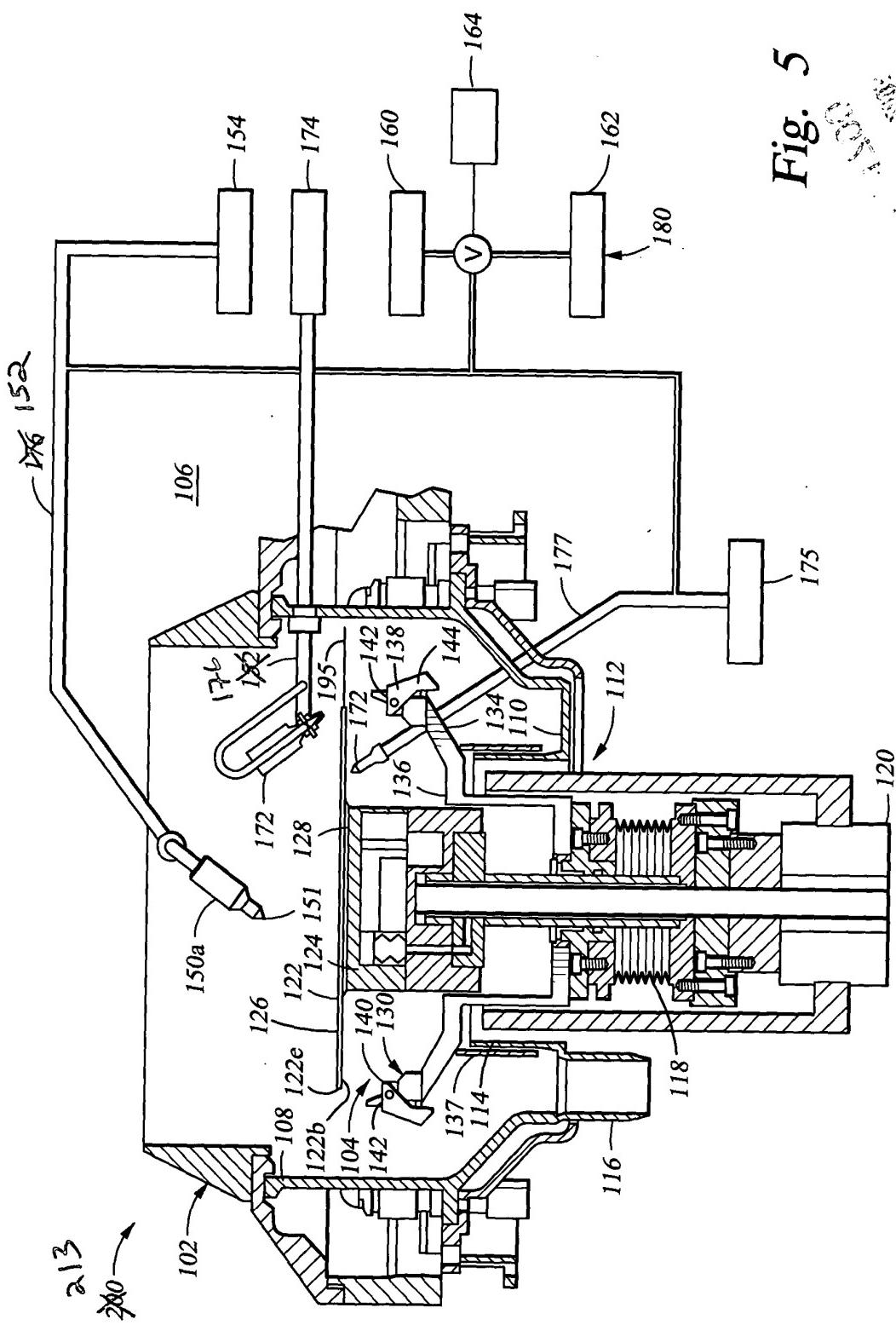


ATTY DKT. NO.: ANNOTATED SHEET SHOWING CHANGES  
U.S. SERIAL NO.: AMAT/6060/CMP/ECP/RKK  
FILED: CONFIRMATION: 7947  
APPLICANT: JANUARY 8, 2002  
TITLE: SYSTEM FOR PLANARIZING METAL CONDUCTIVE LAYERS  
INVENTOR: OLGADO, ET AL.

FIGURE 5

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Fig. 5





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INVENTOR:

ANNOTATED SHEET SHOWING CHANGES  
AMAT/6060/CMP/ECP/RKK  
10/043,561 CONFIRMATION: 7947  
JANUARY 8, 2002  
APPLIED MATERIALS, INC.  
SYSTEM FOR PLANARIZING METAL CONDUCTIVE LAYERS  
OLGADO, ET AL.

FIGURE 7

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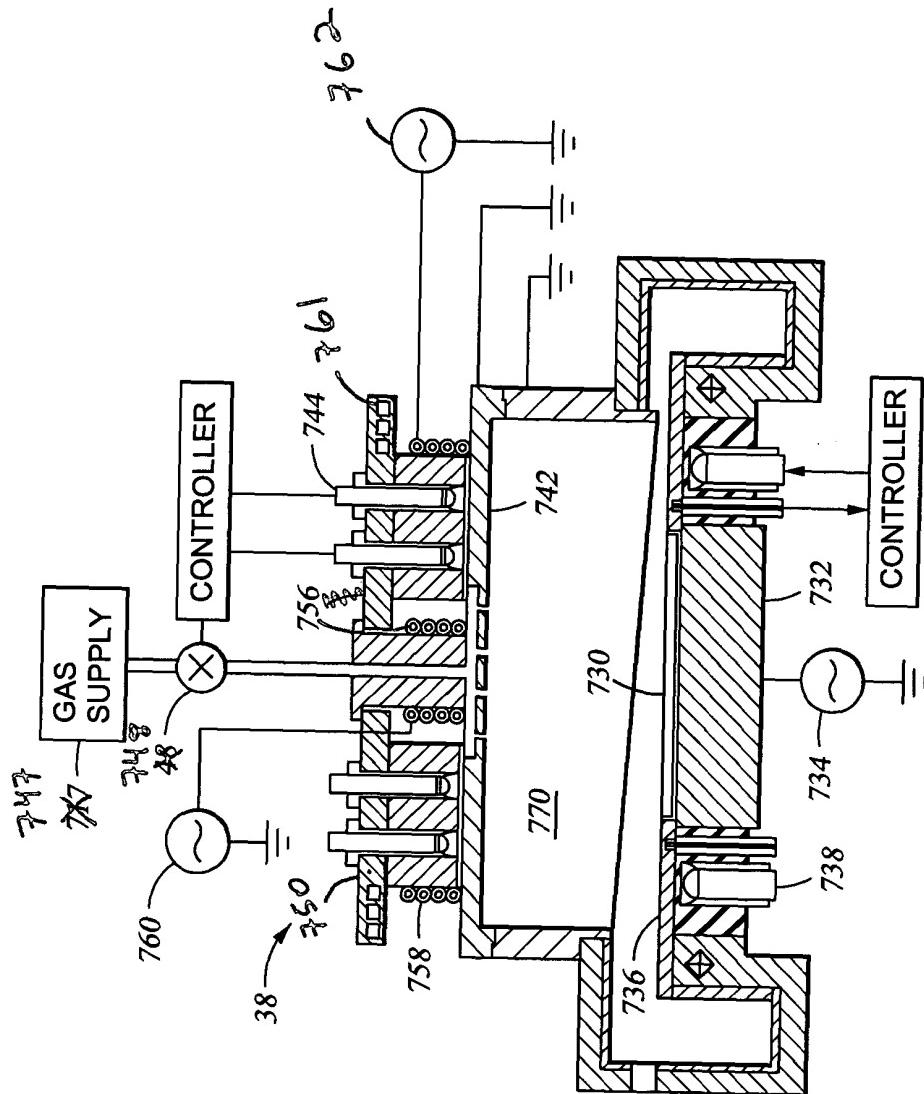


Fig. 7

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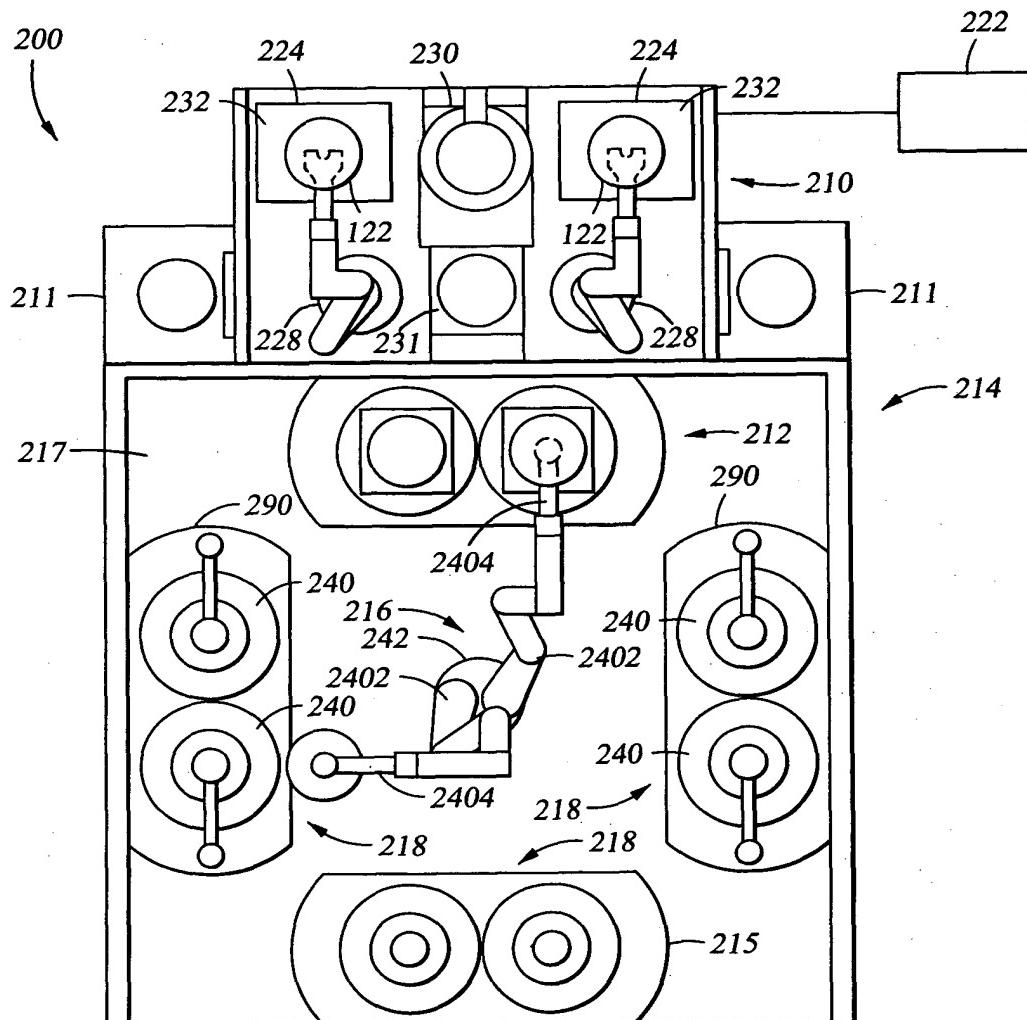


Fig. 1

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**REPLACEMENT SHEET**  
**AMAT/6060/CMP/ECP/RKK**  
**10/043,561** CONFIRMATION: 7  
**JANUARY 8, 2002**  
**APPLIED MATERIALS, INC.**  
**SYSTEM FOR PLANARIZING METAL CONDUCTIVE LAYERS**  
**OLGADO, ET AL.**

SHEET 2 OF 10



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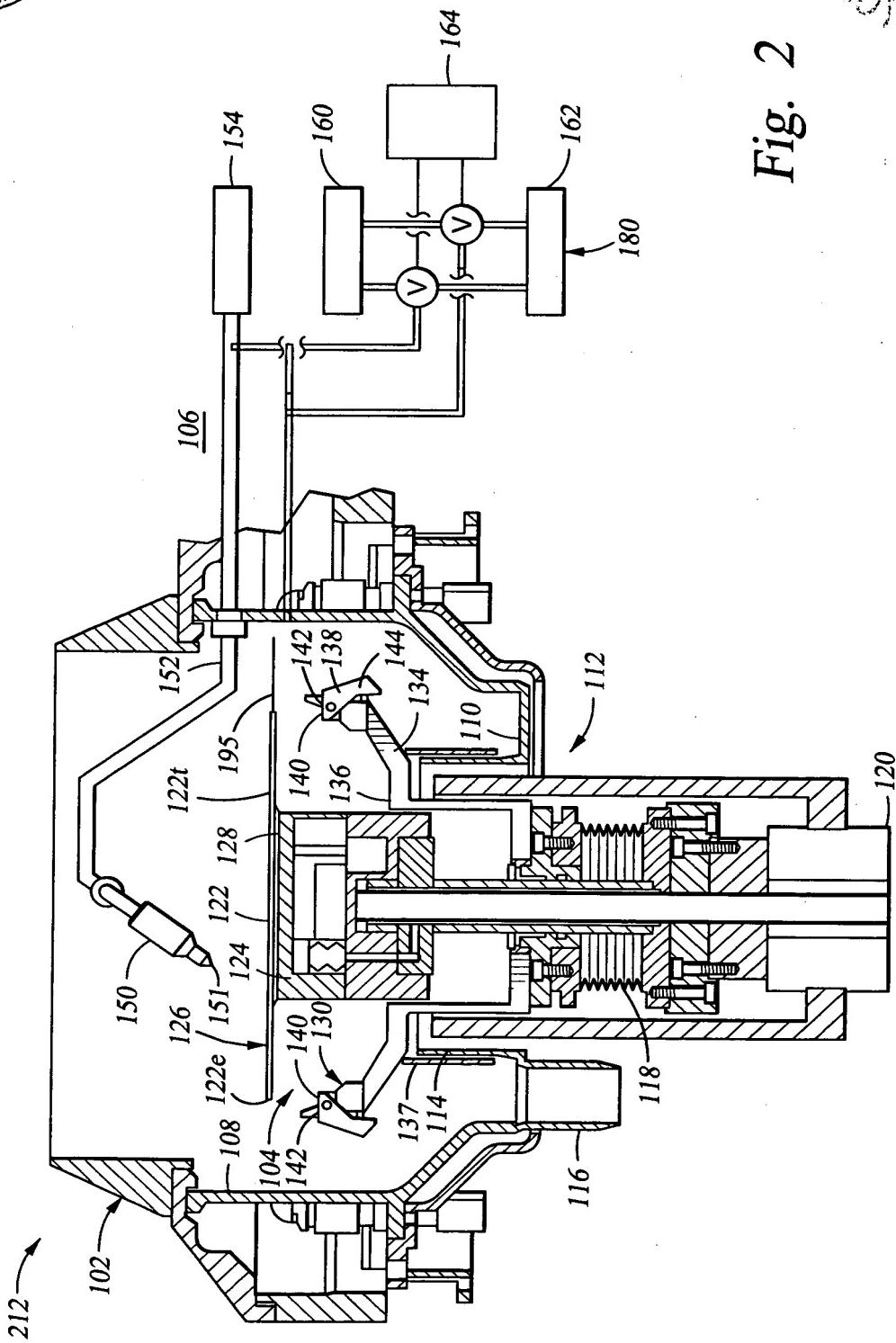


Fig. 2

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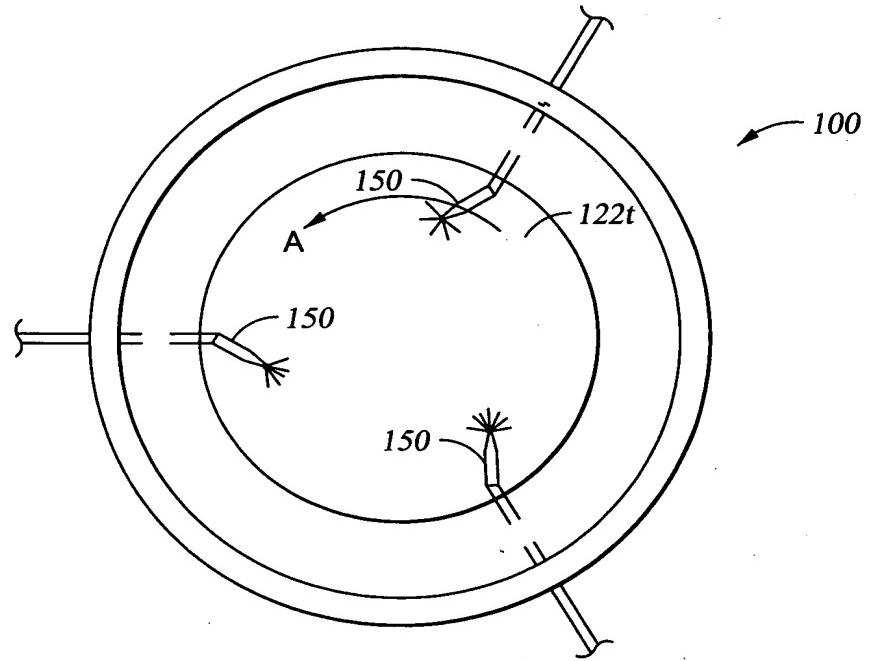


Fig. 3

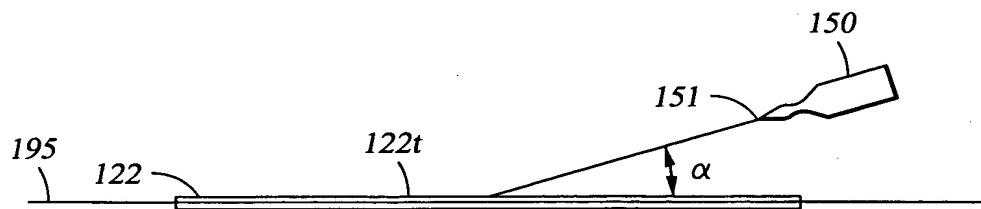


Fig. 4

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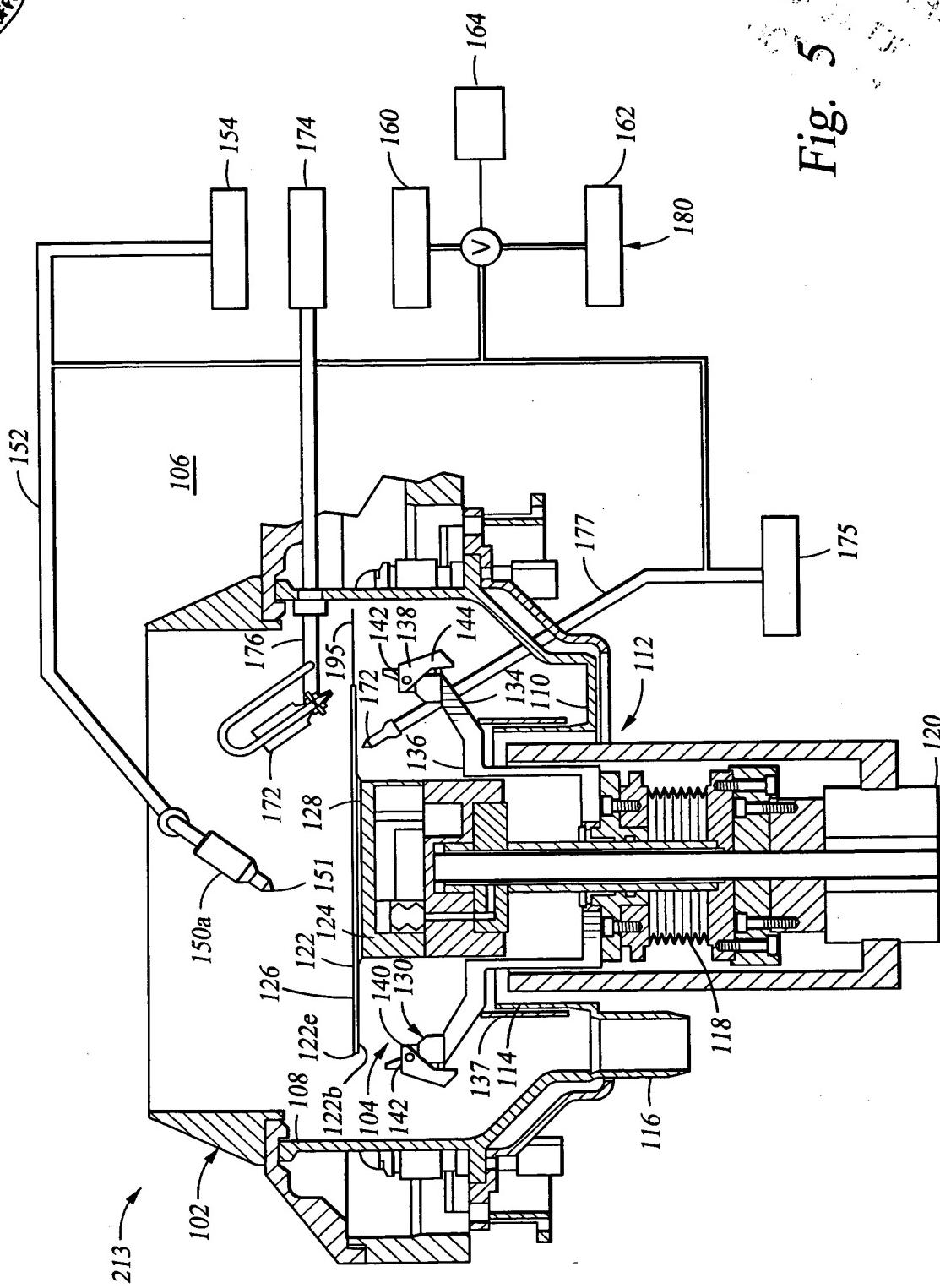


Fig. 5

## REPLACEMENT SHEET

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SHEET 5 OF 10

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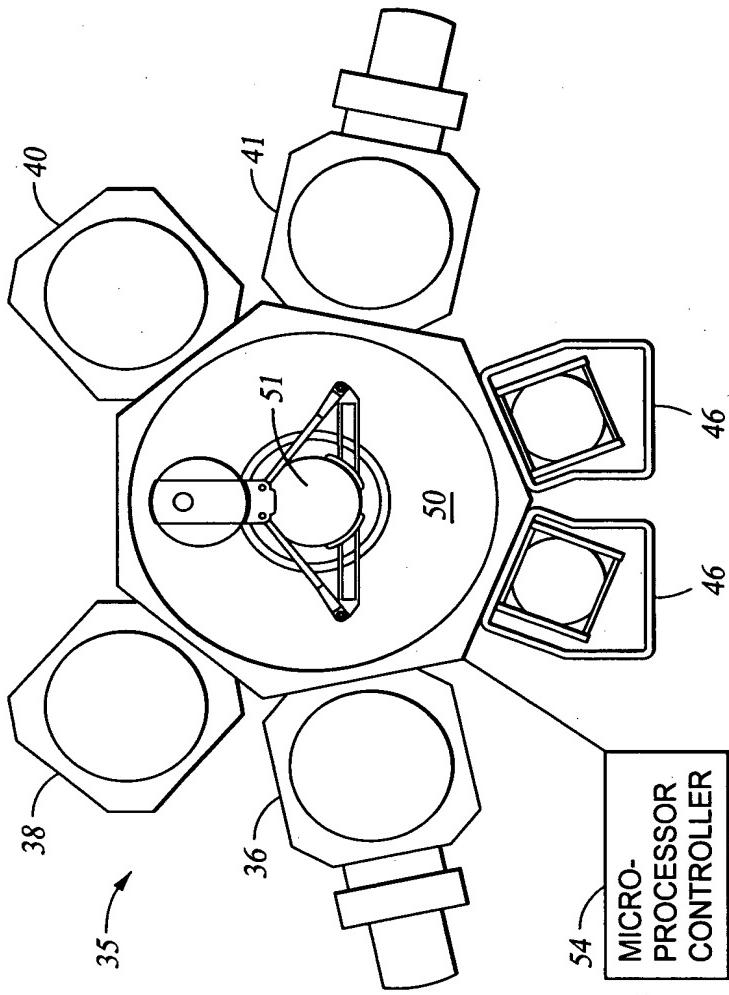


Fig. 6

ATTY DKT. NO.:  
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INVENTOR:

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AMAT/6060/CMP/ECP/RKK  
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JANUARY 8, 2002  
CONFIRMATION: 7947  
APPLIED MATERIALS, INC.  
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OLGADO, ET AL.

SHEET 6 OF 10

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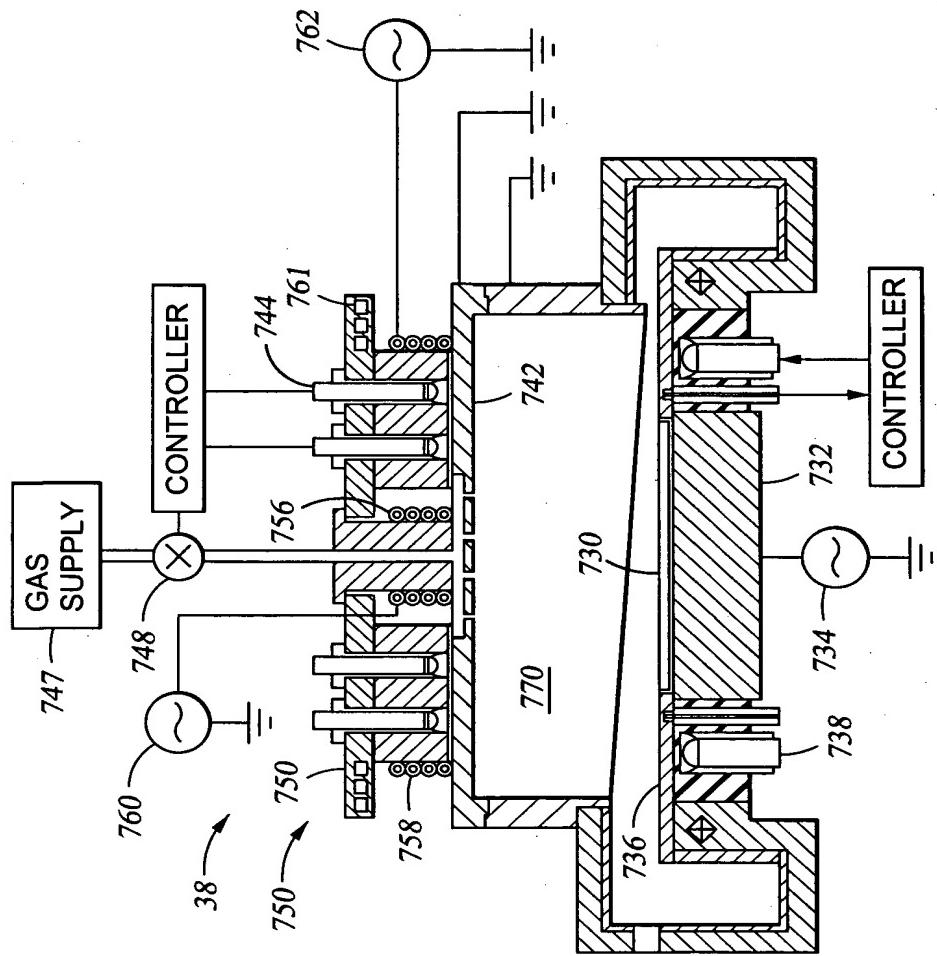
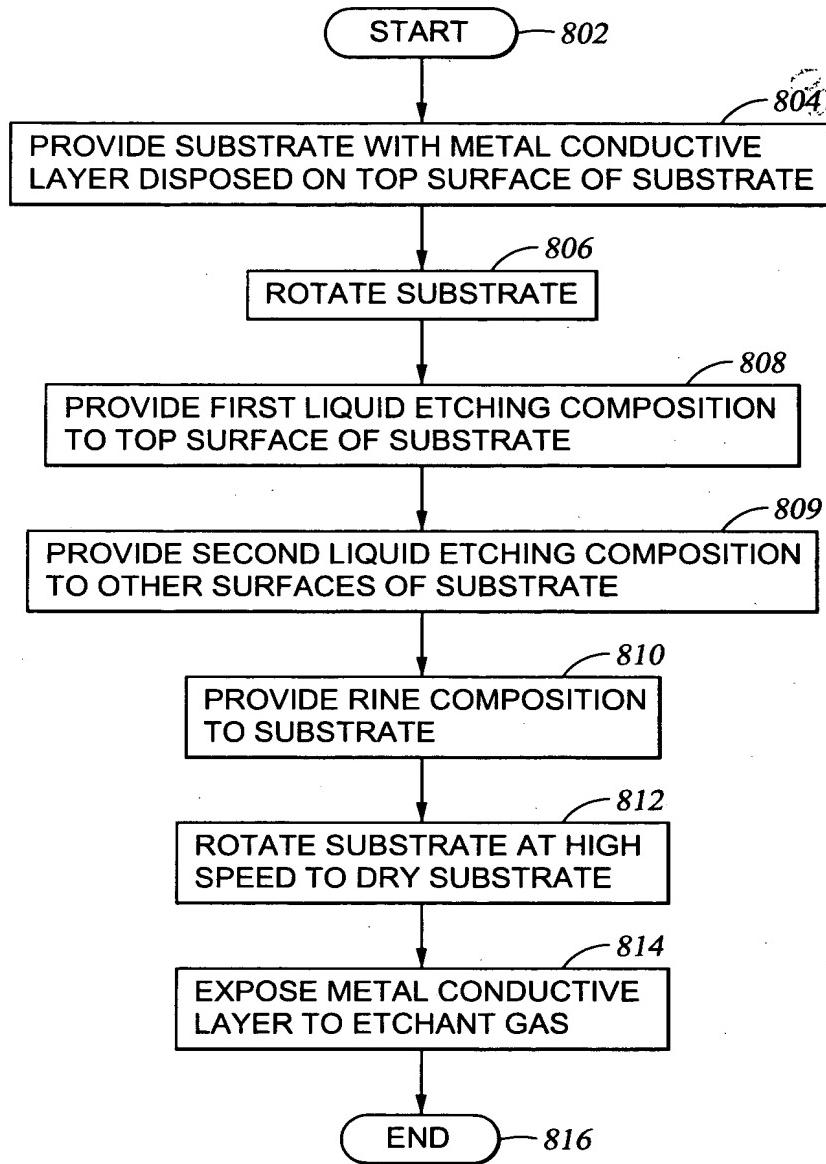


Fig. 7



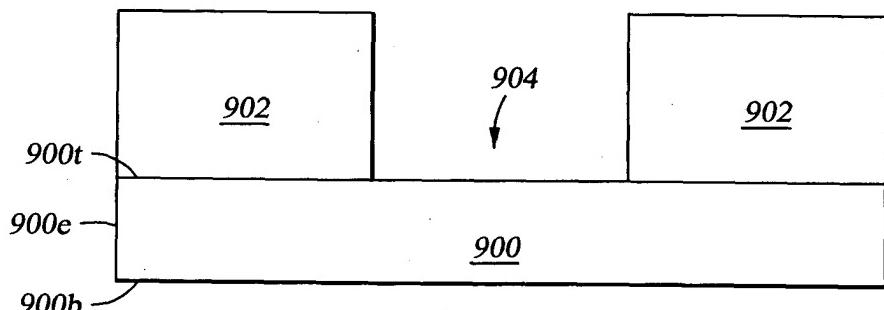
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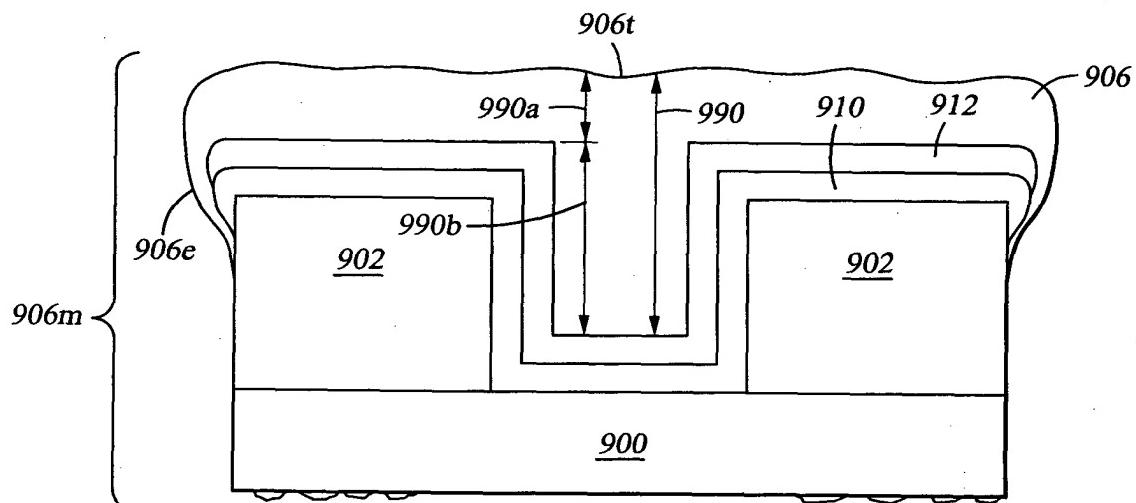


*Fig. 8*

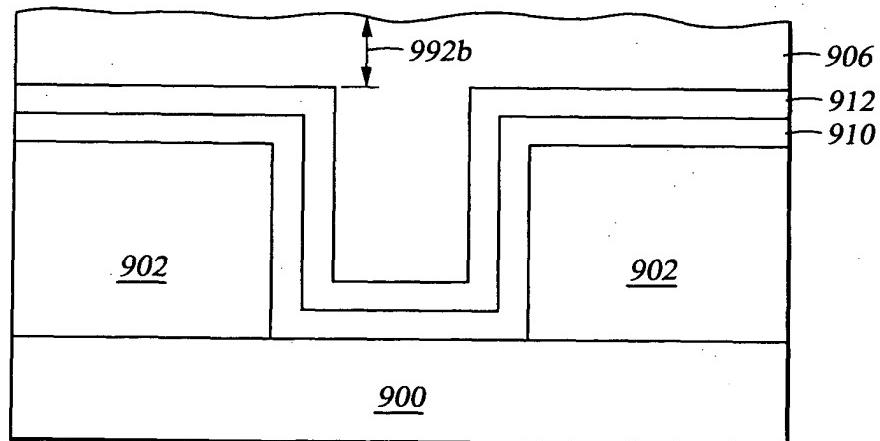
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*Fig. 9A*



*Fig. 9B*

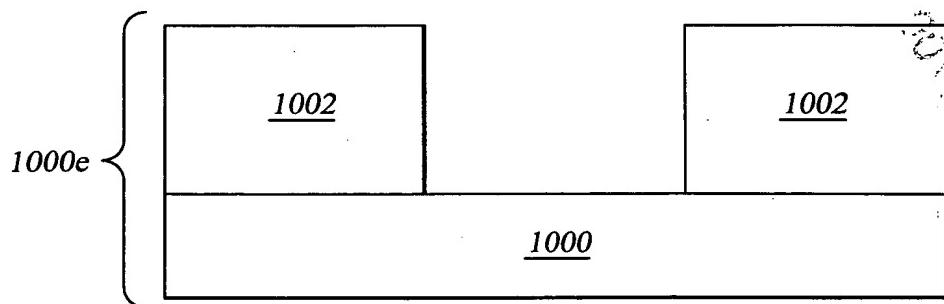


*Fig. 9C*

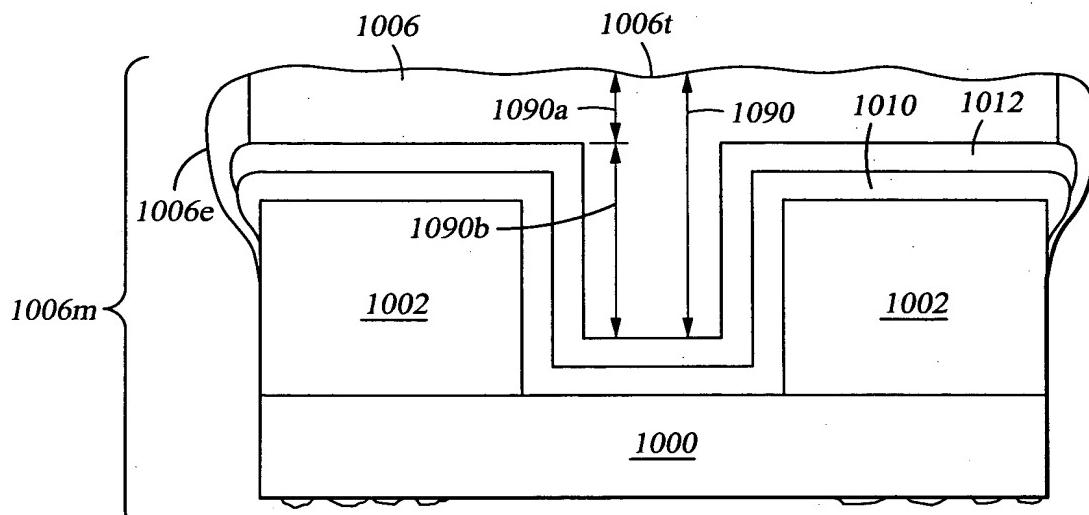




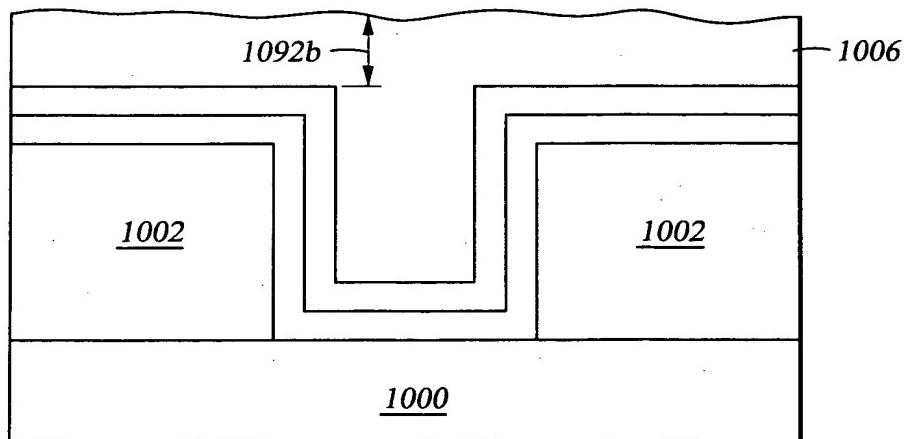
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*Fig. 10A*



*Fig. 10B*



*Fig. 10C*



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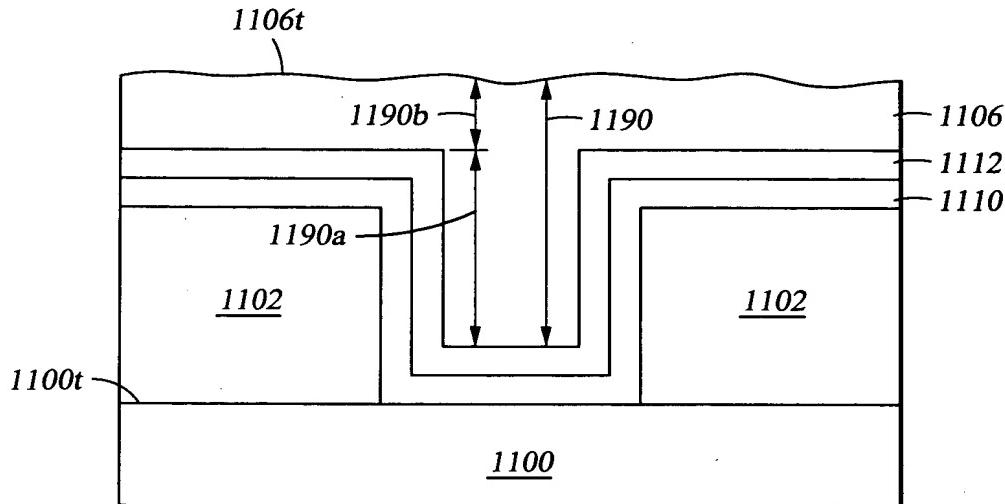


Fig. 11A

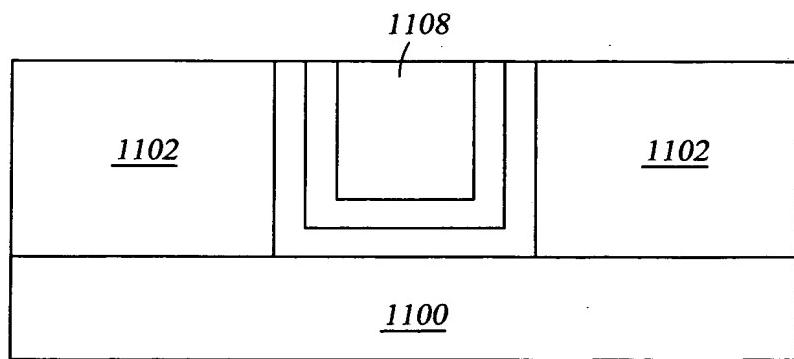


Fig. 11B